



Dual or Quad Selectable Programmable Crystal Oscillator Output: LV-PECL



Product Number
SG-8503CA : X1G005011xxx00
SG-8504CA : X1G005021xxx00

SG-8503CA / SG-8504CA

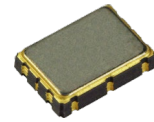
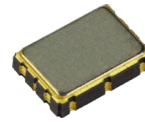
- Dual frequency Selectable: SG-8503CA, 7.0 × 5.0 × 1.5 mm (6 pins)
- Quad frequency Selectable: SG-8504CA, 7.0 × 5.0 × 1.5 mm (8 pins)
- Frequency range: 50 MHz to 800 MHz
- Supply voltage: 2.5 V to 3.3 V

Features

- User-specified two (FSEL) or four (FSEL0, FSEL1) startup frequencies
- High frequency fundamental tone crystal, Low jitter PLL technology
- Available field oscillator programmer "SG-Writer II"

Application

- OTN, BTS, Test Instrument



Specifications (characteristics)

Item	Symbol	Specifications	Conditions / Remarks
Output frequency range	f _o	50 MHz to 800 MHz	-
Supply voltage	V _{CC}	2.5 V - 0.125 V to 3.3 V + 0.33 V	-
Storage temperature	T _{stg}	-55 °C to +125 °C	Store as bare product after packing
Operating temperature	T _{use}	-40 °C to +85 °C	-
Frequency tolerance *1	f _{tol}	K : ±31.5 × 10 ⁻⁶ L : ±50 × 10 ⁻⁶	Customized Product (Option)
Current consumption	I _{CC}	90 mA Max.	OE Active, L _{ECL} = 50 Ω
Disable current	I _{dis}	40 mA Max.	OE Inactive, Output Standby: Hi-Z mode
		70 mA Max.	OE Inactive, Output Standby: Fix mode
Symmetry	SYM	45 % to 55 %	At outputs crossing point
Output voltage	V _{OH}	V _{CC} - 1.025 V Min.	DC characteristics
	V _{OL}	V _{CC} - 1.62 V Max.	
Output load condition	L _{ECL}	50 Ω	Termination to V _{CC} - 2.0 V
Input voltage	V _{IH}	70% V _{CC} Min.	SG-8503CA : OE, FSEL
	V _{IL}	30% V _{CC} Max.	SG-8504CA : OE, FSEL0, FSEL1
Rise time / Fall time	t _r / t _f	400 ps Max.	Between 20% and 80% of (V _{OH} - V _{OL})
Start-up time	t _{str}	10 ms Max.	Time at minimum supply voltage to be 0 s
Setting time for frequency change	t _{SET1}	1.5 ms Max.	SG-8503CA : From setting FSEL pin to output new frequency SG-8504CA : From setting FSEL0 / FSEL1 pin to output new frequency

*1 Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage change, reflow drift and 10 years aging at +25 °C.

Product Name SG-8503 CA 156MHz 625MHz A P R L Z
(Standard form) ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨

① Model, ② Package type,

③ Frequency-0 (50 ~ 800 MHz), ④ Frequency-1 (50 ~ 800 MHz), ⑤ Internal crystal frequency, ⑥ Output enable pin Polarity,

⑦ Supply voltage/Output format, ⑧ Frequency tolerance/Operating temperature, ⑨ Output standby type

Product Name SG-8504 CA 156.2MHz nnnn A P R L Z
(Standard form) ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨

① Model, ② Package type,

③ Frequency-0 (50 ~ 800 MHz), ④ Parameter identifier, ⑤ Internal crystal frequency, ⑥ Output enable pin Polarity,

⑦ Supply voltage/Output format, ⑧ Frequency tolerance/Operating temperature, ⑨ Output standby type

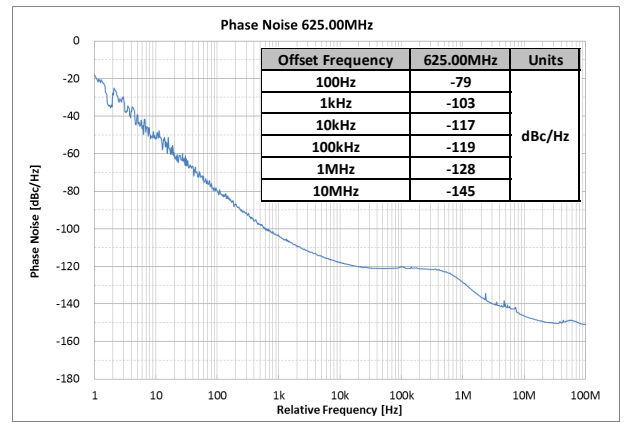
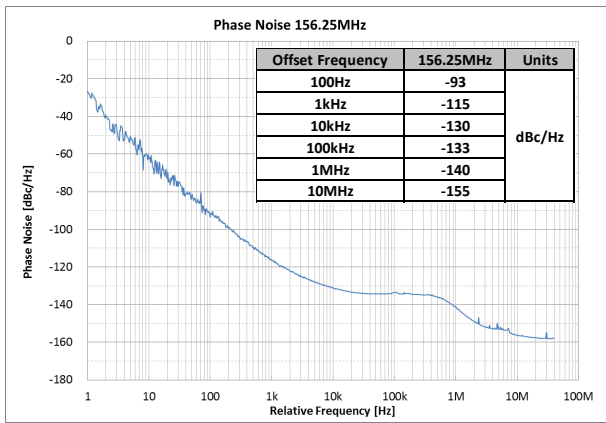
⑤ Internal crystal frequency	⑥ Output enable pin Polarity	⑦ Supply voltage/Output format	⑧ Frequency tolerance/Operating temperature	⑨ Output standby type
A 114.1444 MHz	P Active High Q Active Low	R 2.5 V ~ 3.3 V/LVPECL	K ±31.5 × 10 ⁻⁶ /-40 to +85 °C L ±50 × 10 ⁻⁶ /-40 to +85 °C	F Fix (OUT="L", OUTN="H") Z High-Z

Phase Jitter

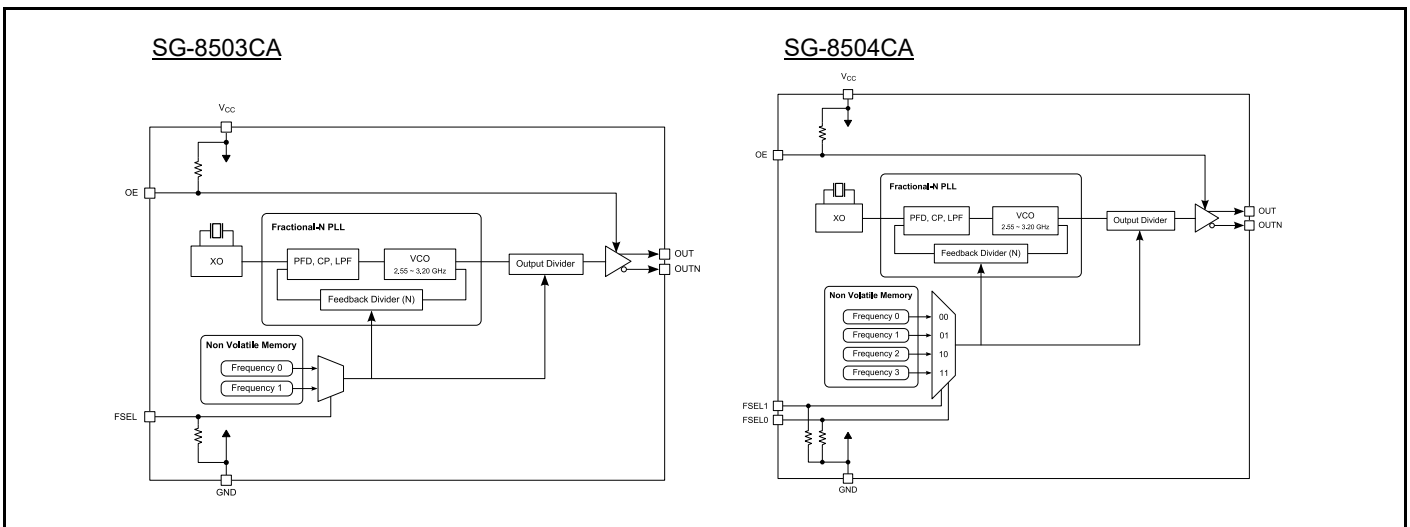
	Offset Frequency	100.00 MHz	125.00 MHz	156.25 MHz	250.00 MHz	312.50 MHz	500.00 MHz	625.00 MHz
Phase jitter *2 Typ.	12 kHz to 20 MHz	0.31 ps	0.30 ps	0.26 ps	0.26 ps	0.29 ps	0.28 ps	0.29 ps

*2 In order to achieve optimum jitter performance, it is recommended that the capacitor (0.1 μF + 10 μF) between V_{CC} and GND pin should be placed as close to the V_{CC} pin as possible.

Phase Noise



Block diagram



External dimensions

(Unit: mm)

Footprint (Recommended)(Unit: mm)

SG-8503CA

Factory Preset Frequency code or SG-Writer II programmable "SG8503"

Pin	Connection
1	OE
2	FSEL (L = Frequency-0, H = Frequency-1)
3	GND
4	OUT
5	OUTN
6	Vcc

SG-8504CA

Factory Preset Frequency code or SG-Writer II programmable "SG8504"

Pin	Connection	Pin	Connection
1	NC	5	OUTN
2	OE	6	Vcc
3	GND	7	FSEL0
4	OUT	8	FSEL1

FSEL1, FSEL0	Output Frequency
LL	Frequency-0
LH	Frequency-1
HL	Frequency-2
HH	Frequency-3

SG-8503CA

SG-8504CA

In order to achieve optimum jitter performance, it is recommended that the capacitor (0.1 μF + 10 μF) between Vcc and GND pin should be placed as close to the Vcc pin as possible.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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► Explanation of the mark that are using it for the catalog

	► Pb free.
	► Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
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